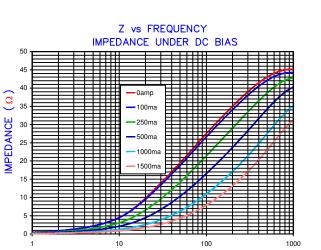
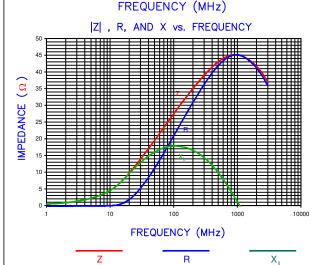
## HI0603R300R-10

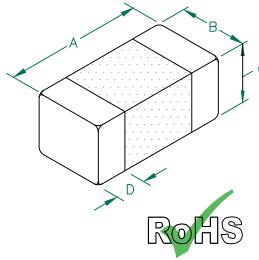
## PHYSICAL DIMENSIONS:

Α	1.60	$\lfloor .063 \rfloor$	<del>-</del> 0.15	[.006]
В	0.80	[.031]	± 0.15	[.006]
С	0.80	[.031]	± 0.15	[.006]
D	0.36	[.014]	± 0.15	[.006]





AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3298

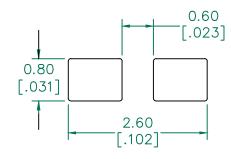


ELECTRICAL CHARACTERISTICS:								
Z @ 100M ( Ω )	1Hz	DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current					
Nominal	30							
Minimum	23							
Maximum	38	0.01	5000 mA					

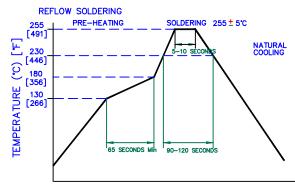
NOTES: UNLESS OTHERWISE SPECIFIED

- TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -55°C~+125°C (INCLUDING SELF-HEATING)
- 5. COSMETIC SPECIFICATION REFER TO WI-QA-124.

## LAND PATTERNS FOR REFLOW SOLDERING



## RECOMMENDED SOLDERING CONDITIONS



(For wave soldering, add 0.762 [.030] to this dimension)

	DIMENSIONS ARE IN mm [INCHE	S).		This print is the property of Lai Tech. and is loaned in confiden subject to return upon request with the understanding that no copies shall be made without th written consent of Laird Tech. A rights to design or invention are reserved.	and ie	La	ir(	
				PROJECT/PART NUMBER:	REV	PART T	rPE:	DRAWN BY:
C	UPDATE LAIRD LOGO AND NOTES 4	08/05/13	Q	HI0603R300R-10	ol c	CO-	-FIRE	FIRE YUKI
В	ADD OPERATING TEMPERATURE	11 /10 /10	QU	THOUGSKSOOK TO	<b>'</b>   `			
	ADD DC BIAS AND UPDATE IR-REFLOW	11/16/12	ų.	DATE: 11/16/12	SCALE:		SHEET:	
Α	ORIGINAL DRAFT	03/01/11	YUKI	KI CAD #			1	of 1
REV	DESCRIPTION	DATE	INT	" HI0603R300R-10-C		-		